

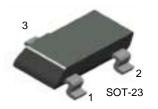
## **FYV0704S**

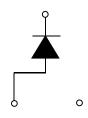
### **Features**

- Very low forward voltage drop
- High frequency properties and switching speed
- Guard ring for over-voltage protection

## **Applications**

- DC-DC converters
- Freewheeling diodes





3. Cathode

marking



## 1. Anode 2. N.C.

## **SCHOTTKY BARRIER RECTIFIER**

### Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	40	V
V <sub>R</sub>	Maximum DC Reverse Voltage	40	V
I <sub>F(AV)</sub>	Average Rectified Forward Current @ T <sub>A</sub> = 40°C	0.75	Α
I <sub>FSM</sub>	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	8	Α
T <sub>J</sub>	Operating Junction Temperature	-65 to +125	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C

### **Thermal Characteristics**

Symbol		Parameter	Value	Units
	$R_{\theta,JA}$	Thermal Resistance, Junction to Ambient	250	°C/W

### **Electrical Characteristics**

Symbol	Parameter		Min.	Тур.	Max.	Units
V <sub>F</sub> *	Forward Voltage Drop					V
	$I_F = 50 \text{mA}$	T <sub>A</sub> = 25 °C	-	0.270	-	
	I <sub>F</sub> = 100mA	T <sub>A</sub> = 25 °C	-	0.290	-	
	$I_{F} = 500 \text{mA}$	T <sub>A</sub> = 25 °C	-	0.380	-	
	I <sub>F</sub> = 750mA	T <sub>A</sub> = 25 °C	-	0.425	0.48	
	I <sub>F</sub> = 1A	T <sub>A</sub> = 25 °C	-	0.460	-	
	I <sub>F</sub> = 1.5A	T <sub>A</sub> = 25 °C	-	0.535	-	
	I <sub>F</sub> = 750mA	T <sub>A</sub> = 125 °C	-	0.375	-	
I <sub>R</sub> *	Reverse Current					mA
••	@ rated V <sub>R</sub>	T <sub>A</sub> = 25 °C	-	0.02	0.1	
		T <sub>A</sub> = 25 °C T <sub>A</sub> = 125 °C	-	10	-	

<sup>\*</sup> Pulse Test: Pulse Width=300μs, Duty Cycle=2%

# **Typical Characteristics**

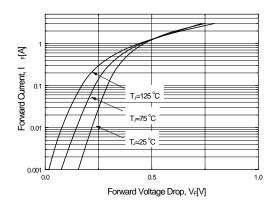


Figure 1. Typical Forward Voltage Characteristics

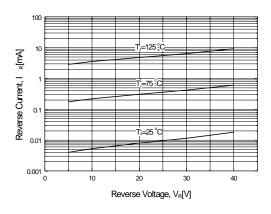


Figure 2. Typical Reverse Current vs. Reverse Voltage

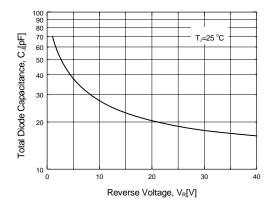


Figure 3. Total Diode Capacitance

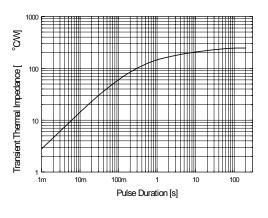


Figure 4. Thermal Impedance Characteristics

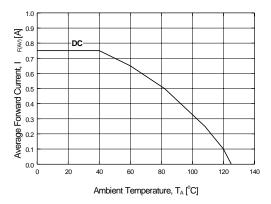


Figure 5. Forward Current Derating Curve

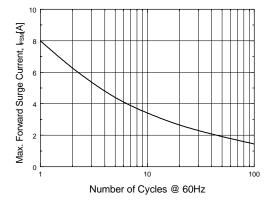
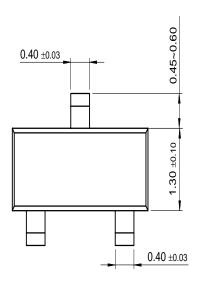


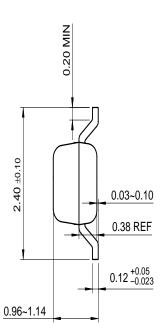
Figure 6. Non-Repetive Surge Current

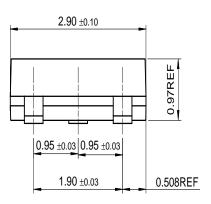
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# **Package Dimensions**

# SOT-23







Dimensions in Millimeters

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EnSigna™	MicroFET™	SLIENT SWITCHER®	
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Rev. H2

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